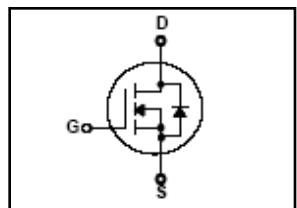


## HRS140N06K 60V N-Channel Trench MOSFET

### FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 40 nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 11.5 mΩ (Typ.) @  $V_{GS}=10V$
- 100% Avalanche Tested

$BV_{DSS} = 60 V$   
 $R_{DS(on)\ typ} = 11.5 m\Omega$   
 $I_D = 40 A$



### Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise specified

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain-Source Voltage	60	V
$I_D$	Drain Current – Continuous ( $T_C = 25^\circ C$ )	40 *	A
	Drain Current – Continuous ( $T_C = 100^\circ C$ )	28 *	A
$I_{DM}$	Drain Current – Pulsed (Note 1)	140 *	A
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	145	mJ
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	2.9	mJ
$P_D$	Power Dissipation ( $T_C = 25^\circ C$ )	29	W
	- Derate above $25^\circ C$	0.19	W/ $^\circ C$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	$^\circ C$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ C$

\* Drain current limited by maximum junction temperature

### Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	5.2	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

**Electrical Characteristics**  $T_J=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**On Characteristics**

$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	2.2	--	3.8	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 15 \text{ A}$	--	11.5	14	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 20$ , $I_D = 15 \text{ A}$	--	60	--	S

**Off Characteristics**

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	60	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}$ , $V_{GS} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 48 \text{ V}$ , $T_J = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	$\pm 100$	nA

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$	--	2150	--	pF
$C_{oss}$	Output Capacitance		--	200	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	130	--	pF
$R_g$	Gate Resistance	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 0 \text{ V}$ , $f = 1\text{MHz}$	--	1.6	--	$\Omega$

**Switching Characteristics**

$t_{d(on)}$	Turn-On Time	$V_{DS} = 30 \text{ V}$ , $I_D = 15 \text{ A}$ , $R_G = 6 \Omega$	--	30	--	ns
$t_r$	Turn-On Rise Time		--	20	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	120	--	ns
$t_f$	Turn-Off Fall Time		--	25	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 48 \text{ V}$ , $I_D = 15 \text{ A}$ , $V_{GS} = 10 \text{ V}$	--	40	--	nC
$Q_{gs}$	Gate-Source Charge		--	10	--	nC
$Q_{gd}$	Gate-Drain Charge		--	13	--	nC

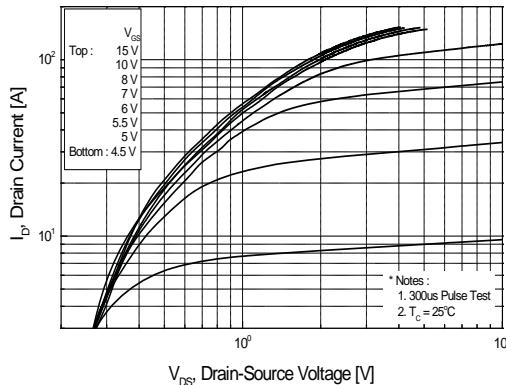
**Source-Drain Diode Maximum Ratings and Characteristics**

$I_S$	Continuous Source-Drain Diode Forward Current	--	--	40	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	140		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 15 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	--	1.3	V
$trr$	Reverse Recovery Time	$I_S = 15 \text{ A}$ , $V_{GS} = 0 \text{ V}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$	--	40	--	ns
$Qrr$	Reverse Recovery Charge		--	45	--	nC

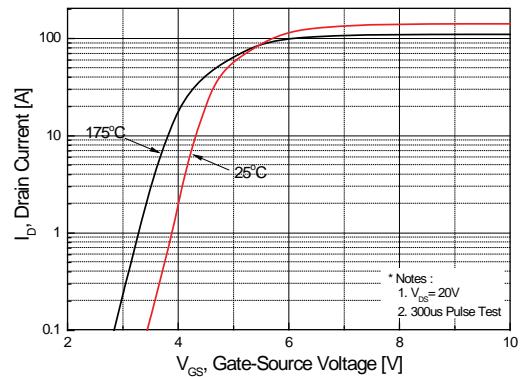
**Notes :**

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $L=1\text{mH}$ ,  $I_{AS}=13\text{A}$ ,  $V_{DD}=25\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

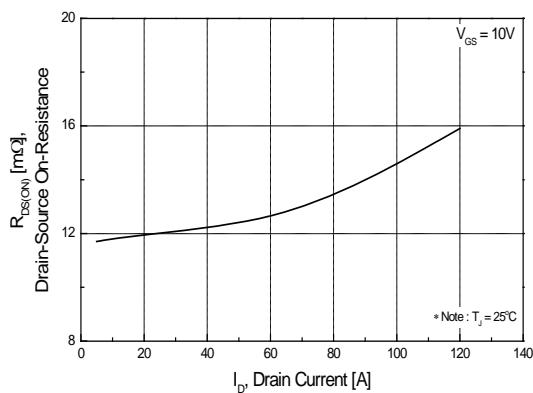
## Typical Characteristics



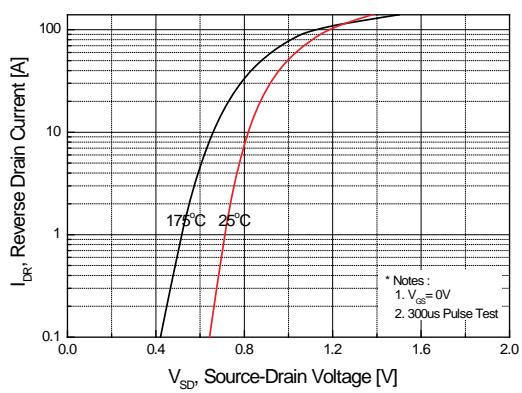
**Figure 1. On Region Characteristics**



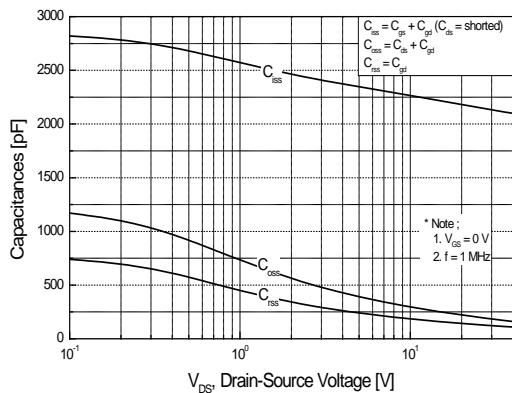
**Figure 2. Transfer Characteristics**



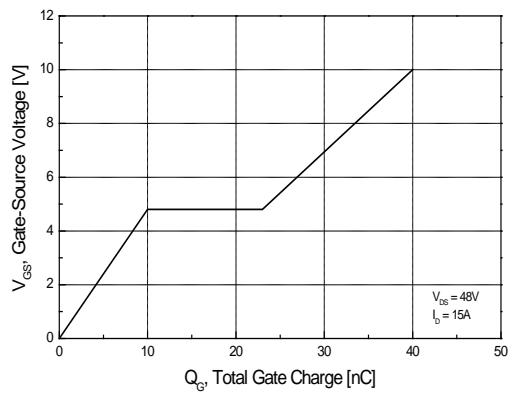
**Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

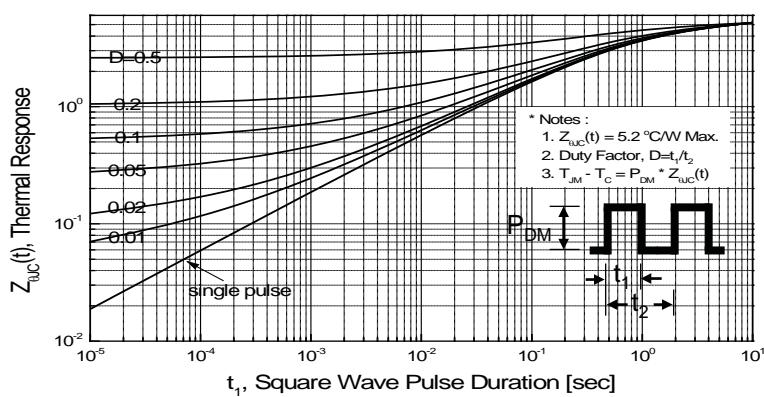
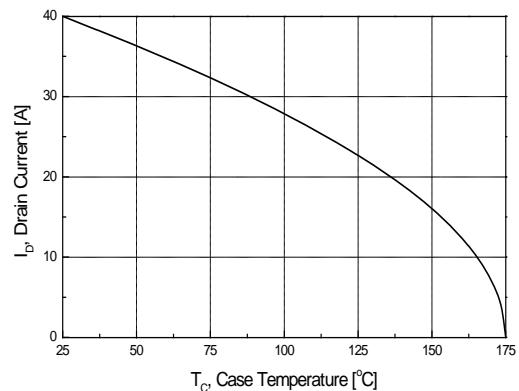
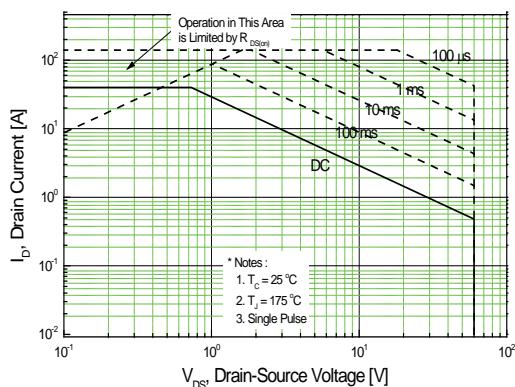
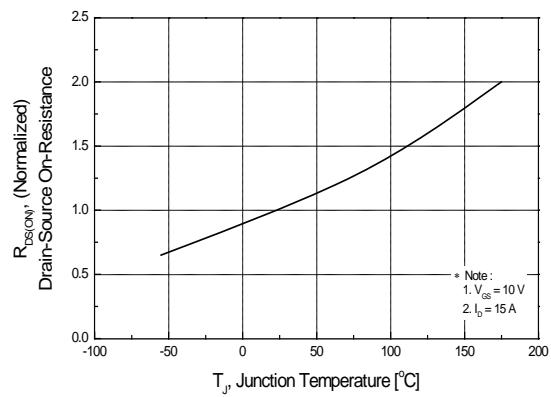
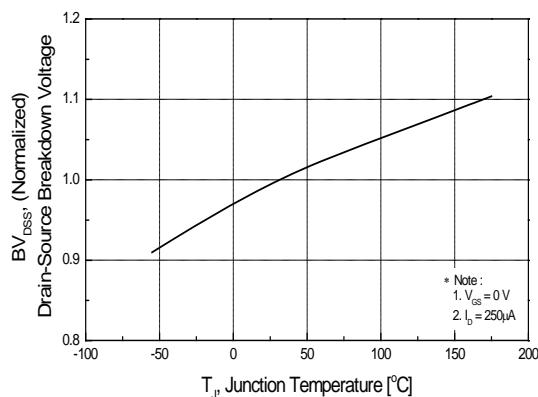


**Figure 5. Capacitance Characteristics**

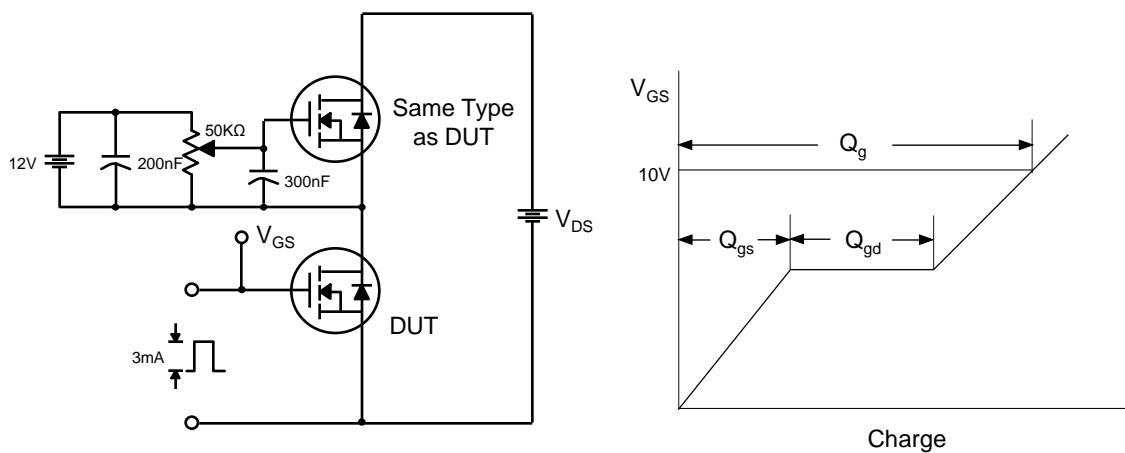


**Figure 6. Gate Charge Characteristics**

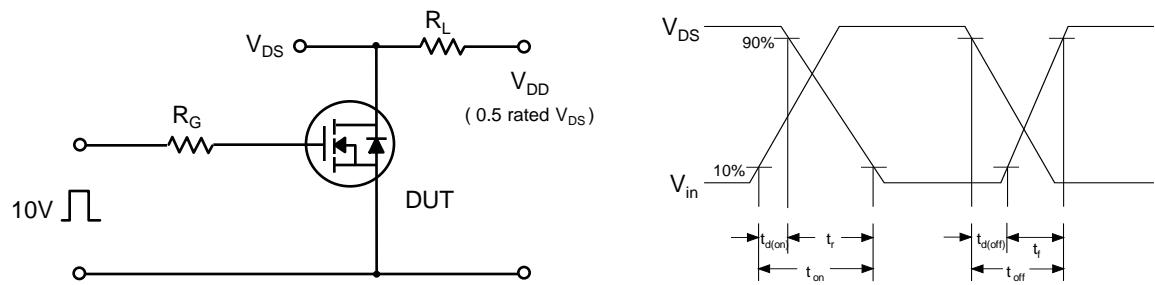
## Typical Characteristics (continued)



**Fig 12. Gate Charge Test Circuit & Waveform**



**Fig 13. Resistive Switching Test Circuit & Waveforms**



**Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

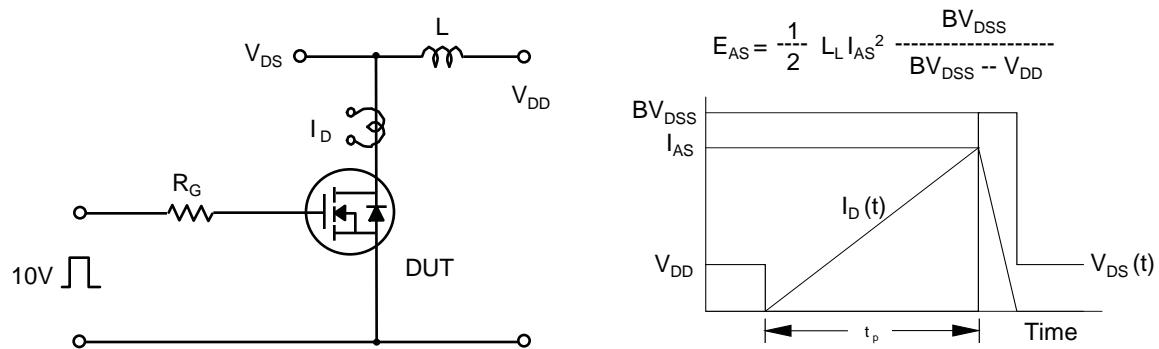
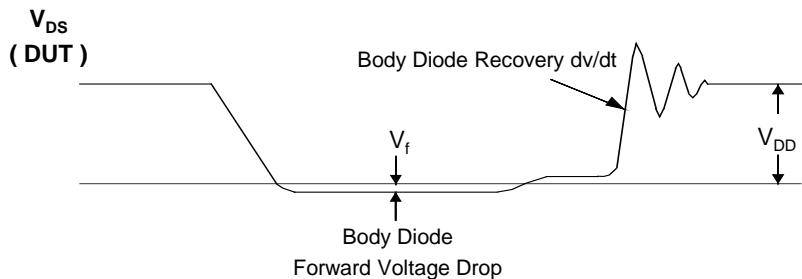
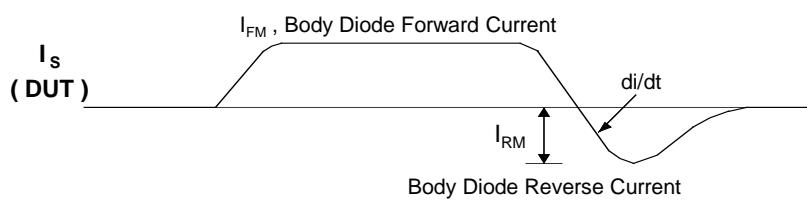
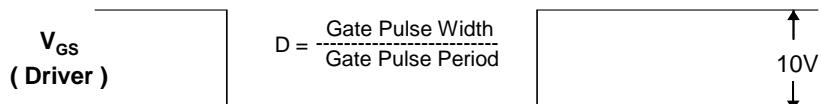
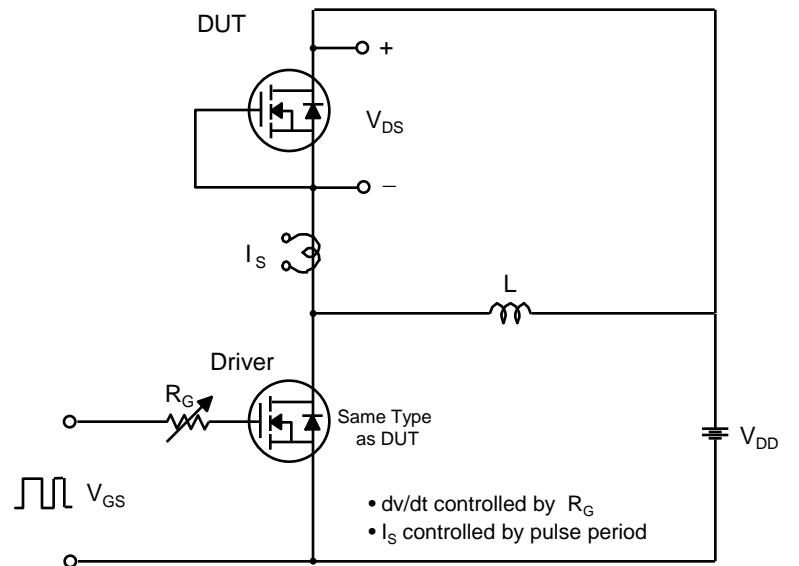


Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



**Package Dimension****TO-220F**